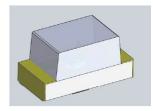


# DATASHEET

# 0.8mm Height Flat Top Infrared LED IR19-21C/TR8(BY)



#### **Features**

- Small double-end package
- Low forward voltage
- Good spectral matching to Si photo detector
- Pb free
- The product itself will remain within RoHS compliant version
- Compliance with EU REACH
- Compliance Halogen Free .(Br <900 ppm ,Cl <900 ppm , Br+Cl < 1500 ppm).

# **Descriptions**

- IR19-21C/TR8(BY) is an infrared emitting diode in miniature SMD package which is molded in a water clear plastic with flat view lens
- The device is spectrally matched with silicon photodiode and phototransistor

### **Applications**

- PCB mounted infrared sensor
- Infrared emitting for miniature light barrier
- Floppy disk drive
- Optoelectronic switch
- Smoke detector

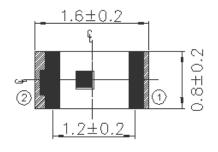
#### **Device Selection Guide**

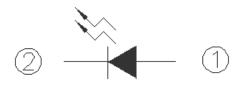
Part Category	Chip Material	Lens Color
IR	GaAlAs	Water Clear



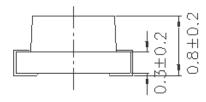
Chip Phototransistor with Right Angle Lens IR19-21C/TR8(BY)

# **Package Dimensions**





- ① Anode
- 2 Cathode



For refiow soldering (Propose)

2±0.2

0.8±0.2

Cathode mark (1+0.2)

Notes: 1.All dimensions are in millimeters

- 2.Tolerances unless dimensions ±0.1mm
- 3.Suggested pad dimension is just for reference only Please modify the pad dimension based on individual need

# **EVERLIGHT**

# **Chip Phototransistor with Right Angle Lens** IR19-21C/TR8(BY)

Absolute Maximum Ratings (Ta=25°C)

Parameter	Symbol	Rating	Units
Continuous Forward Current	I <sub>F</sub>	65	mA
Reverse Voltage	V <sub>R</sub>	5	V
Operating Temperature	T <sub>opr</sub>	-25 ~ +85	$^{\circ}\!\mathbb{C}$
Storage Temperature	T <sub>stg</sub>	-40 ~ +85	$^{\circ}\!\mathbb{C}$
Soldering Temperature*1	T <sub>sol</sub>	260	$^{\circ}\!\mathbb{C}$
Power Dissipation at (or below) 25° Free Air Temperature	$P_d$	130	mW

**Notes:** \*1: Soldering time ≤ 5 seconds

Electro-Optical Characteristics (Ta=25°C)

Electro-Optical Offaracteristics (Ta=25 C)								
Parameter	Symbol	Condition	Min.	Тур.	Max.	Units		
Radiant Intensity	le		0.5	0.9		mW/sr		
Peak Wavelength	λр	124		940		nm		
Spectral Bandwidth	Δλ	I <sub>F</sub> =20mA		50		nm		
Forward Voltage	V <sub>F</sub>			1.2	1.5	V		
View Angle	201/2			150		deg		
Reverse Current	I <sub>R</sub>	V <sub>R</sub> =5V			10	μA		



## **Typical Electro-Optical Characteristics Curves**

Fig. 1 Forward Current vs.

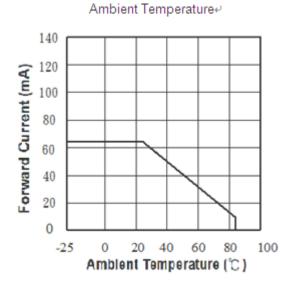
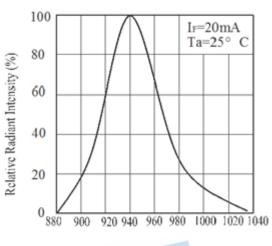


Fig.2 Spectral Distribution₽



Wavelength λ (nm)

Fig. 3 Forward Current vs.
Forward Voltage

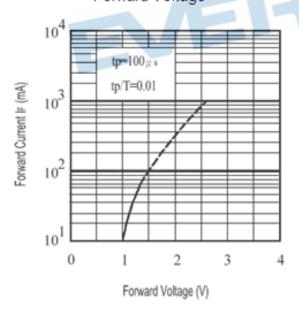
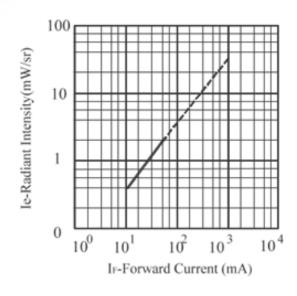


Fig. 4 Radiant Intensity vs. ↔ Forward Current ↔

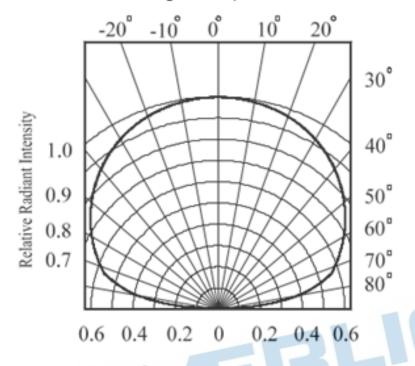




Chip Phototransistor with Right Angle Lens IR19-21C/TR8(BY)

# Typical Electro-Optical Characteristics Curves-

Fig. 5 Relative Radiant Intensity vs. ↔
Angular Displacement ↔



Ver.:2

### **Chip Phototransistor with Right Angle Lens** IR19-21C/TR8(BY)



#### **Precautions For Use**

#### 1. Over-current-proof

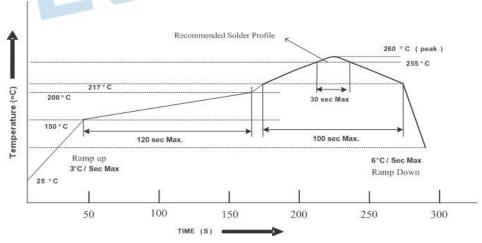
Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

#### 2. Storage

- 2.1 Do not open moisture proof bag before the products are ready to use.
- 2.2 Before opening the package, the LEDs should be kept at  $10^{\circ}$ C ~ $30^{\circ}$ C and  $90^{\circ}$ RH or less.
- 2.3 The LEDs suggested be used within one year.
- 2.4 After opening the package, the devices must be stored at  $10^{\circ}$ C  $\sim 30^{\circ}$ C and  $\leq 60^{\circ}$ RH, and used within 168 hours (floor life). If unused LEDs remain, it should be stored in moisture proof packages.
- 2.5 If the moisture absorbent material (desiccant material) has faded or unopened bag has exceeded the shelf life or devices (out of bag) have exceeded the floor life, baking treatment is required.
- 2.6 If baking is required, refer to IPC/JEDEC J-STD-033 for bake procedure or recommend the following conditions:
  - 96 hours at  $60^{\circ}$ C ±  $5^{\circ}$ C and < 5 % RH (reeled/tubed/loose units).

#### 3. Soldering Condition

3.1 Pb-free solder temperature profile



- 3.2 Reflow soldering should not be done more than two times
- 3.3 When soldering, do not put stress on the LEDs during heating
- 3.4 After soldering, do not warp the circuit board

#### Data Sheet

### **Chip Phototransistor with Right Angle Lens** IR19-21C/TR8(BY)

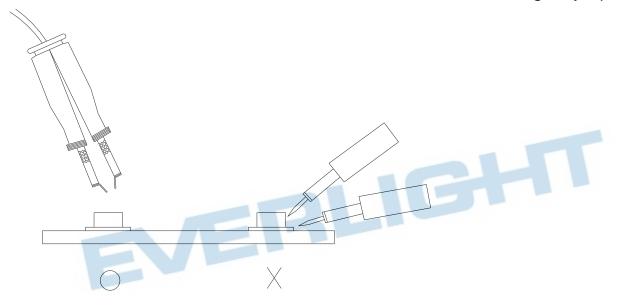


#### 4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350°C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

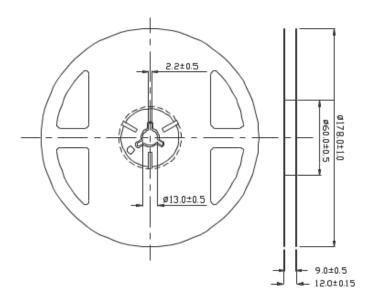
#### 5. Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



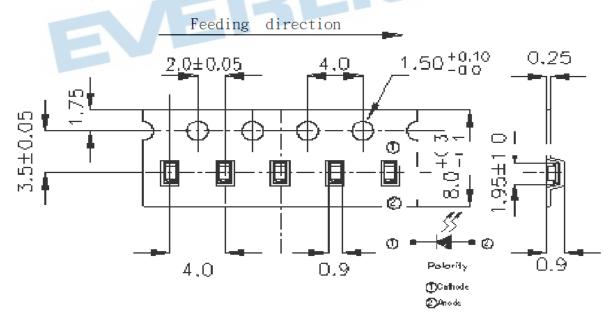


### **Package Dimensions**



Note: The tolerances unless mentioned are ±0.1mm, Unit: mm

# Carrier Taping Dimensions: (Quantity: 3000PCS/Reel)

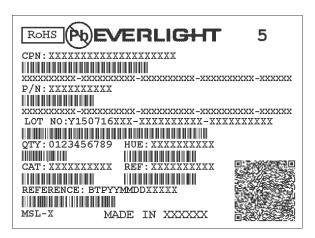


Note: The tolerances unless mentioned are ±0.1mm, Unit: mm

Chip Phototransistor with Right Angle Lens IR19-21C/TR8(BY)



### **Label Form Specification**



CPN: Customer's Production Number

P/N: Production Number

LOT No: Lot Number QTY: Packing Quantity HUE: Peak Wavelength

CAT: Ranks

**REF: Reference** MSL-X: MSL Level

Made In: Manufacture place

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- 1. EVERLIGHT reserves the right(s) on the adjustment of product material mix for the specification.
- 2. The product meets EVERLIGHT published specification for a period of twelve (12) months from date of shipment.
- 3. The graphs shown in this datasheet are representing typical data only and do not show guaranteed values.
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EVERLIGHT ELECTRONICS CO., LTD.

Office: No. 6-8, Zhonghua Rd., Shulin Dist.,

New Taipei City 23860, Taiwan

Tel: 886-2-2685-6688 Fax: 886-2685-2699 , 6897

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